

Title (en)

HERMETIC CHAMBER WITH ELECTRICAL FEEDTHROUGHS

Title (de)

HERMETISCHE KAMMER MIT ELEKTRISCHEN DURCHSPEISUNGEN

Title (fr)

COMPARTIMENT HERMETIQUE PRESENTANT DES ELEMENTS D'ALIMENTATION ELECTRIQUE

Publication

EP 1851524 A2 20071107 (EN)

Application

EP 06718195 A 20060113

Priority

- US 2006001095 W 20060113
- US 65167005 P 20050210
- US 65386805 P 20050217

Abstract (en)

[origin: US2006177956A1] A method of manufacturing a hermetically-sealed chamber with an electrical feedthrough includes the step of hermetically fixing an electrode to a substrate in a predetermined location on the substrate. A passage is formed through the substrate through the predetermined location such that at least a portion of the electrode is exposed to the passage. The passage is then at least partially filled with an electrically conductive material. A housing is then formed including the substrate such that the housing defines a chamber, with the electrode being disposed within the housing and the chamber being hermetically sealed. The electrode within the chamber can be placed in electrical communication with an exterior electrical component by way of the electrically conductive material in the passage.

IPC 8 full level

G01L 7/00 (2006.01)

CPC (source: EP US)

B81B 7/007 (2013.01 - EP US); **B81C 1/00301** (2013.01 - EP US); **G01L 9/0073** (2013.01 - EP US); **G01L 9/0075** (2013.01 - EP US); **A61B 5/03** (2013.01 - EP US); **A61B 2562/0247** (2013.01 - EP US); **B81B 2201/0264** (2013.01 - EP US); **B81B 2201/06** (2013.01 - EP US); **B81B 2207/096** (2013.01 - EP US)

Cited by

US11039813B2; US11206992B2; US11944495B2; US10806352B2; US11701018B2; US11779238B2; US10806428B2; US10905393B2

Designated contracting state (EPC)

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Designated extension state (EPC)

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DOCDB simple family (publication)

US 2006177956 A1 20060810; **US 7662653 B2 20100216**; AU 2006213090 A1 20060817; AU 2006213090 B2 20111006; AU 2006213091 A1 20060817; CA 2597078 A1 20060817; CA 2597289 A1 20060817; EP 1851524 A2 20071107; EP 1851524 A4 20110803; EP 1851791 A2 20071107; US 2006174712 A1 20060810; US 2009145623 A1 20090611; US 7854172 B2 20101221; WO 2006086113 A2 20060817; WO 2006086113 A3 20071115; WO 2006086114 A2 20060817; WO 2006086114 A3 20070531

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US 31469605 A 20051220; AU 2006213090 A 20060113; AU 2006213091 A 20060113; CA 2597078 A 20060113; CA 2597289 A 20060113; EP 06718195 A 20060113; EP 06718199 A 20060113; US 2006001095 W 20060113; US 2006001101 W 20060113; US 31404605 A 20051220; US 37227409 A 20090217